



IGT™ TRANSISTORS

Insulated Gate Bipolar Transistor

IGT8D21,E21

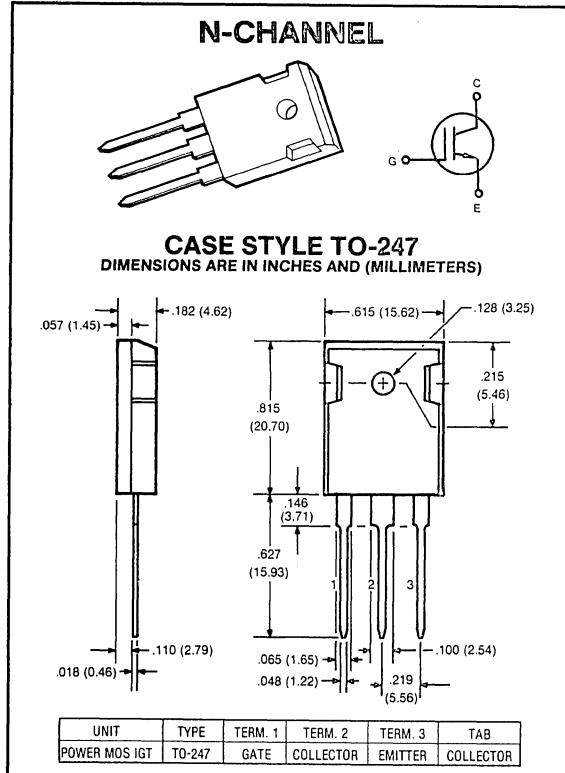
20 AMPERES
400, 500 VOLTS
EQUIV. R_{D5(ON)} = 0.145 Ω

This IGT™ Transistor (Insulated Gate Bipolar Transistor) is a new type of MOS-gate turn on/off power switching device combining the best advantages of power MOSFETs and bipolar transistors. The result is a device that has the high input impedance of MOSFETs and the low on-state conduction losses similar to bipolar transistors. The device design and gate characteristics of the IGT™ Transistor are also similar to power MOSFETs. An important difference is the equivalent R_{D5(ON)} drain resistance which is modulated to a low value (10 times lower) when the gate is turned on. The much lower on-state voltage drop also varies only moderately between 25°C and 150°C offering extended power handling capability.

The IGT™ Transistor is ideal for many high voltage switching applications operating at low frequencies and where low conduction losses are essential, such as; AC and DC motor controls, power supplies and drivers for solenoids, relays and contactors.

Features:

- Low V_{CE(SAT)} — 2.5V typ @ 20A
- Ultra-fast turn-on — 150 ns typical
- Polysilicon MOS gate — Voltage controlled turn on/off
- High current handling — 20 amps @ 90°C



maximum ratings (T_C = 25°C) (unless otherwise specified)

RATING	SYMBOL	IGT8D21	IGT8E21	UNITS
Collector-Emitter Voltage, V _{GE} = 0V	V _{CES}	400	500	Volts
Collector-Gate Voltage, R _{GE} = 1MΩ	V _{CGR}	400	500	Volts
Continuous Drain Current @ T _C = 90°C @ T _C = 25°C	I _C	20 32	20 32	A A
Pulsed Collector Current ⁽¹⁾	I _{CM}	80	80	A
Gate-Emitter Voltage	V _{GE}	±25	±25	Volts
Total Power Dissipation @ T _C = 25°C Derate Above 25°C	P _D	125 1.0	125 1.0	Watts W/°C
Operating and Storage Junction Temperature Range	T _J , T _{STG}	-55 to 150	-55 to 150	°C

thermal characteristics

Thermal Resistance, Junction to Case	R _{θJC}	1.0	1.0	°C/W
Maximum Lead Temperature for Soldering Purposes: ½" from Case for 5 Seconds	T _L	260	260	°C

(1) Repetitive Rating: Pulse width limited by max. junction temperature.

electrical characteristics ($T_C = 25^\circ C$) (unless otherwise specified)

CHARACTERISTIC	SYMBOL	MIN	TYP	MAX	UNIT
off characteristics					
Collector-Emitter Breakdown Voltage ($V_{GE} = 0V$, $I_C = 250\mu A$)	IGT8D21 IGT8E21	BV _{CES}	400 500	— —	— — Volts
Collector Cut-off Current ($V_{CE} = \text{Max Rating}$, $V_{GE} = 0V$, $T_C = 25^\circ C$) ($V_{CE} = \text{Max Rating} \times 0.8$, $V_{GE} = 0V$, $T_C = 125^\circ C$) ⁽²⁾	I_{CES}	— —	— —	250 4.0	μA mA
Gate-Emitter Leakage Current ($V_{GE} = \pm 20V$)	I_{GES}	—	—	± 500	nA

(2) Applies for $3.3^\circ C$ per watt maximum thermal resistance, case to ambient.

on characteristics⁽³⁾

Gate Threshold Voltage ($V_{CE} = V_{GE}$, $I_C = 500\mu A$)	$T_C = 25^\circ C$ $T_C = 150^\circ C$	$V_{GE(TH)}$	2 —	4 2	5 —	Volts
Collector-Emitter Saturation Voltage $I_C = 20 A$, $T_C = 25^\circ C$, $V_{GE} = 15V$ $I_C = 20 A$, $T_C = 150^\circ C$, $V_{GE} = 15V$ $I_C = 20 A$, $T_C = 25^\circ C$, $V_{GE} = 10V$		$V_{CE(SAT)}$	— — —	2.5 2.6 3.0	2.9 — —	Volts

dynamic characteristics

Input Capacitance	$V_{GE} = 0V$	C_{ies}	—	2300	—	pF
Output Capacitance	$V_{CE} = 25V$	C_{oes}	—	700	—	pF
Reverse Transfer Capacitance	$f = 1 MHz$	C_{res}	—	10	—	pF

switching characteristics⁽³⁾ (see figures 8 & 9)

Turn-on Delay Time	Resistive Load $T_C = 125^\circ C$ $I_C = 20A$, $V_{CE} = \text{Rated } V_{CES}$ $V_{GE} = 15V$ $R_{G(on)} = 50\Omega$, $R_{GE} = 100\Omega$	$t_{d(on)}$	—	100	—	ns
Rise Time		t_r	—	150	—	ns
Turn-off Delay Time		$t_{d(off)}$	—	0.60	—	μs
Fall Time		t_f	—	3.0	—	μs
Turn-off Delay Time	Inductive Load, $T_C = 125^\circ C$, $L = 550\mu H$, $I_C = 20A$, $V_{CE(CLAMP)} = \text{Rated } V_{CES}$ $V_{GE} = 15V$ $R_{G(on)} = 50\Omega$, $R_{GE} = 100\Omega$	$t_{d(off)}$	—	0.8	1.4	μs
Fall Time		t_f	—	0.8	1.0	μs
Equivalent Fall Time		$t_{f(eq)}$	—	0.6	0.8	μs
Turn-off Switching Losses		E_f	—	2.6 3.2	3.2 4.0	mJ

(3) Pulse test: Pulse widths $\leq 300 \mu sec$, duty cycle $\leq 2\%$.

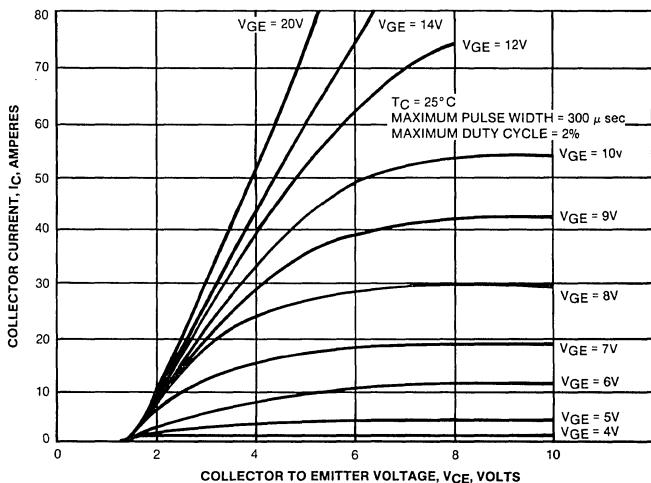


FIGURE 1. TYPICAL OUTPUT CHARACTERISTICS

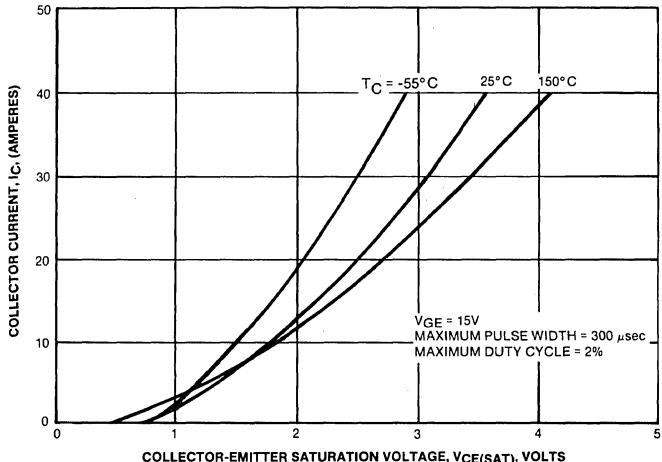


FIGURE 2. TYPICAL COLLECTOR-EMITTER SATURATION VOLTAGE

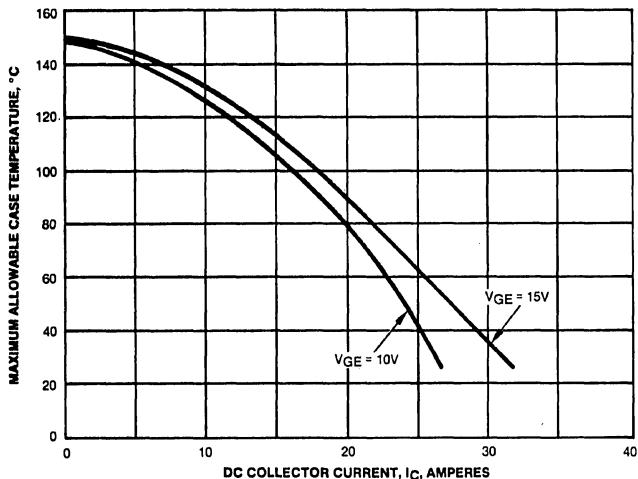


FIGURE 3. MAXIMUM ALLOWABLE CASE TEMPERATURE VS. DC COLLECTOR CURRENT

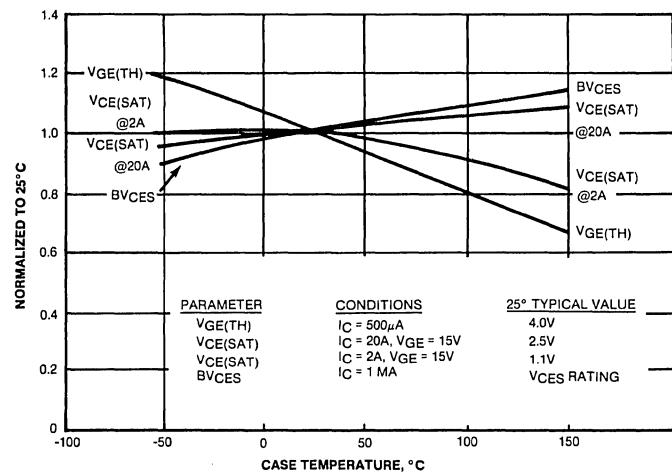


FIGURE 4. TYPICAL TEMPERATURE DEPENDENCE OF PARAMETERS

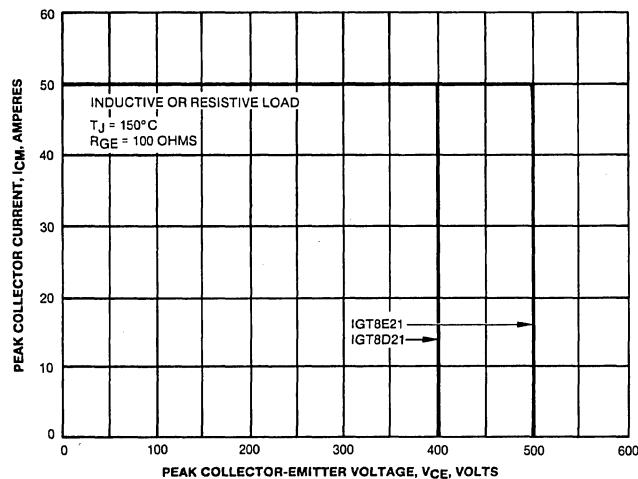


FIGURE 5. TURN-OFF SAFE OPERATING AREA

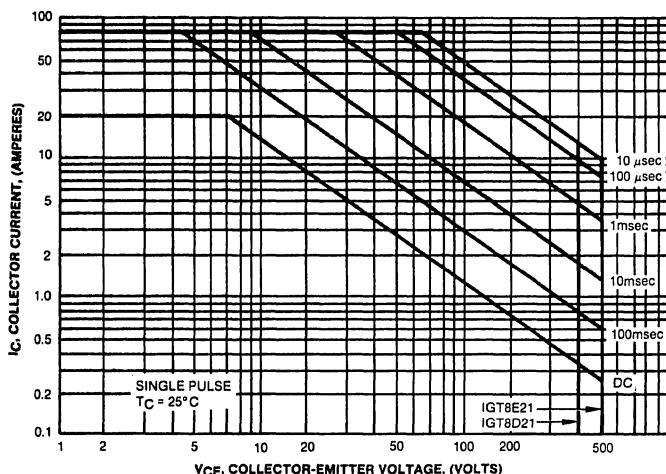


FIGURE 6. TURN-ON SAFE OPERATING AREA

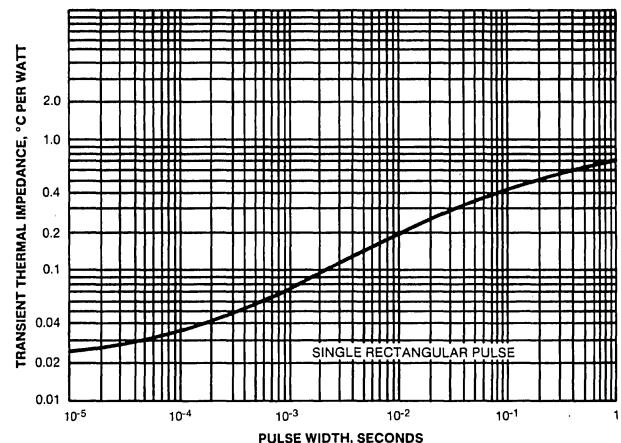


FIGURE 7. MAXIMUM TRANSIENT THERMAL IMPEDANCE

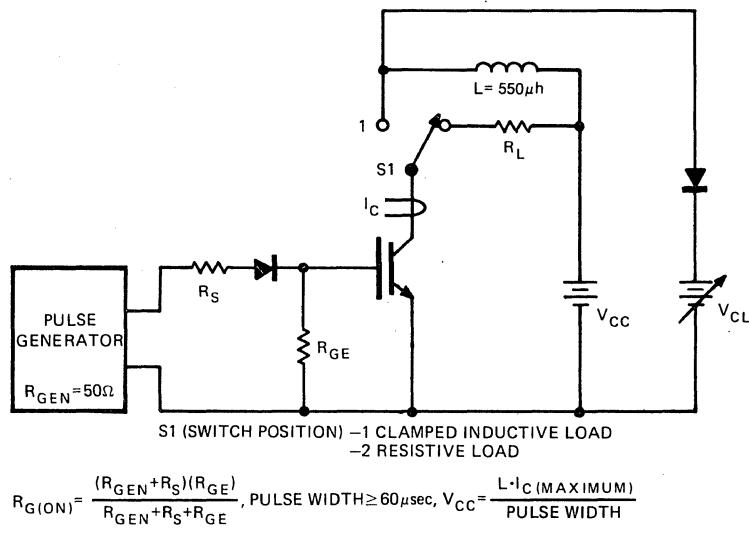


FIGURE 8. BASIC SWITCHING TEST CIRCUIT

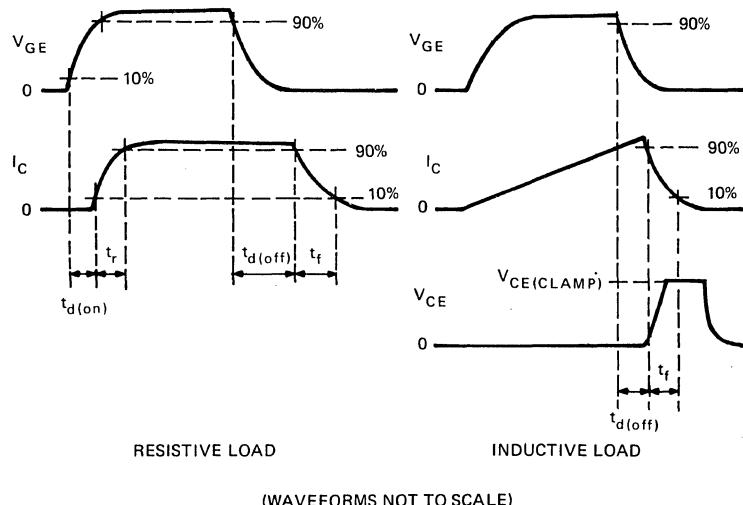


FIGURE 9. SWITCHING WAVEFORMS